

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Product image**

























High-temperature-resistant, straight, open pin header. Packed in box or tape. On tape and with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

## General ordering data

Version	PCB plug-in connector, male header, open side, THT/THR solder connection, 5.08 mm, Number of poles: 16, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1838120000</u>
Туре	SL-SMT 5.08HC/16/180 3.2SN BK BX
GTIN (EAN)	4032248348183
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date March 25, 2021 3:46:09 PM CET



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# **Technical data**

## **Dimensions and weights**

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Net weight	6 g
Width	81.28 mm	Width (inches)	3.2 inch

## **System specifications**

Product family	OMNIMATE Signal - series	Type of connection	
	BL/SL 5.08		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		5.08 mm
Pitch in inches (P)	0.2 inch	Outgoing elbow	180°
Number of poles	16	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.5 mm
Solder eyelet hole diameter tole	rance (D)+ 0,1 mm	L1 in mm	76.2 mm
L1 in inches	3 inch	Number of rows	1
Pin series quantity	1	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	9 N
Pulling force/pole, max.	7 N		

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 µm Ni / 24 µm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt	- '	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

#### Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
tostod dec. to staridard	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



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# **Technical data**

#### Rated data acc. to CSA

Institute (CSA)	€ C	Certificate No. (CSA)	
	OB.		000000 1170015
Rated voltage (Use group B / CSA)	300 V	Poted voltage (Llee group D. / CSA)	200039-1176845 300 V
Rated current (Use group D / CSA)	300 V	Rated voltage (Use group D / CSA) Reference to approval values	Specifications are
nated current (ose group b / csA)	18.5 A	meterice to approval values	maximum values, details see approval certificate.
Rated data acc. to UL 1059			
Institute (UR)	<i>27</i> .	Certificate No. (UR)	
			E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
D 1 .	n	VDE	4
Packaging	Box	VPE length	1 mm
VPE width	1 mm	VPE height	1 mm
Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note	
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized
	standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Gold-plated contact surfaces on request
	Rated current related to rated cross-section & min. No. of poles.
	• Diameter of solder eyelet D = 1.4+0.1mm
	• Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles
	• P on drawing = pitch
	<ul> <li>Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> </ul>
	<ul> <li>Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months</li> </ul>



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# **Technical data**

#### **Approvals**

Approvals

ROHS	Conform
UL File Number Search	E60693

#### **Downloads**

Approval/Certificate/Document of	CB Certificate
Conformity	CB Testreport
·	Declaration of the Manufacturer
Engineering Data	<u>STEP</u>
Engineering Data	EPLAN, WSCAD



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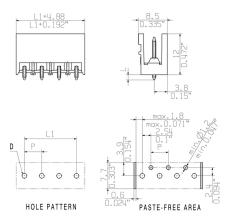
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# **Drawings**

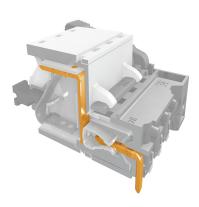
# **Product image**



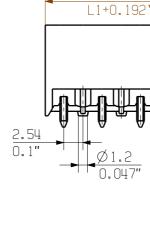
# **Dimensional drawing**

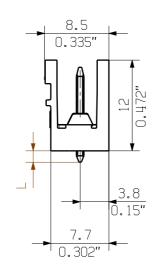


## **Product benefits**



Safe power transmission Proven properties





M 1:1

116,84

111,76

106,68

101,60

96,52

91,44

86,36

81,28

76,20

71,12

66,04

60,96

55,88

50,80

45,72

40,64

Cat.no.:

Sheet 01 of 04 sheets

Drawing no.

4,600 4,400

4,200 4,000

3,800

3,600

3,400

3,200

3,000

2,800

2,600

2,400

2,200

2,000

1,800

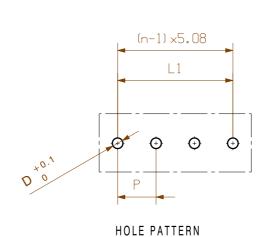
1,600

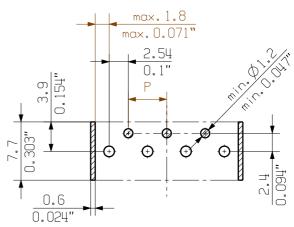
Issue no

7280



L1+4.88 ±0.1





PASTE-FREE AREA

D =	1 4/0 055" 0	or 1.5/0.059"(F	REFLOW S	OLDERING)
-		IDATION FOR		
		R n = 28 / 1.		

n = POLZAHL/NO OF POLES

P=RASTER/PITCH

Supersedes:

SHOWN: SL-SMT 5.08HC/04/180

		8	35,56	1,400
	0.0	7	30,48	1,200
1,5	0,0	6	25,40	1,000
	-0,3	5	20,32	0,800
3,2	0,1 -0,3	4	15,24	0,600
	0,1	3	10,16	0,400
4,5	-0,3	2	5,08	0,200
STIETI AFNGE I	TOI FRANZ	n	L1 [mm]	L1 [Inch]

RoHS	DIN ISO 2768-m						
COMPLIANT	511 100 2700 III	106339/4 30.07.18 HE	RTEL_S	00	We	idmül	lle
		Modifi	cation				
ſ	7 6		Date		Name		
Ţ		Drawn	30.11.200	07	HELIS_MA	SL-	S N
		Responsible			HERTEL_S	0 -	U 18
Scale: 2:	1	Checked	01.08.201	18	KOCH_JG		

Approved

SL-SMT 5.08HC/../180...

STIFTLEISTE MALE HEADER

Product file: SL-SMT 5.08HC

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



# Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

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Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

## Single Wave:



#### **Double Wave:**



## Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



# Recommended reflow soldering profile

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## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.